

FORM PTO-1449

Department of Commerce  
Patent and Trademark Office

Atty. Docket No.  
P29987

Application No.  
10/595,914

INFORMATION DISCLOSURE STATEMENT  
BY APPLICANT  
(Use several sheets if necessary)

Applicant  
Akira OTANI et al.

Filing Date  
I.A. Filed December 2, 2004

Group  
1773

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	2001 / 0 0 0 8 1 6 9	07/19/01	CONNELL et al.			
	5 2 4 0 7 6 1	08/31/93	CALHOUN et al.			

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
11	- 1 2 1 0 7 2	04/30/99	JAPAN			
2002	- 5 1 9 4 7 3	07/02/02	JAPAN			
2000	- 1 4 9 6 7 7	05/30/00	JAPAN			
2002	- 3 5 8 8 2 5	12/13/02	JAPAN			
2003	- 0 6 4 3 2 4	03/05/03	JAPAN			
2	- 1 1 7 9 8 0	05/02/90	JAPAN			
6	- 3 4 9 3 3 9	12/22/94	JAPAN			
	2 8 9 5 8 7 2	03/05/99	JAPAN			
	3 1 6 5 4 7 7	03/02/01	JAPAN			
6	- 0 6 0 7 1 2	03/04/94	JAPAN			
6	- 0 4 5 0 2 4	02/18/94	JAPAN			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

1	English Language Abstract of JP 11-121072.
2	English Language Abstract of JP 2000-149677.
3	English Language Abstract of JP 2002-358825.
4	English Language Abstract of JP 2003-064324.
5	English Language Abstract of JP 6-349339.
6	English Language Abstract of JP 2895872.
7	English Language Abstract of JP 3165477.
8	English Language Abstract of JP 6-060712.
9	English Language Abstract of JP 6-045024.
10	U.S. Application Serial No. 10/567,022 filed February 3, 2006 and entitled "COMPOSITE POROUS MEMBRANE AND PROCESS FOR PRODUCING THE SAME".
11	U.S. Application Serial No. 10/574,837 filed April 6, 2006 and entitled "POLYOXYMETHYLENE RESIN COMPOSITION AND MOLDINGS THEREOF".
12	U.S. Application Serial No. 10/576,259 filed April 18, 2006 and entitled "POLYTRIMETHYLENE TEREPHTHALATE REINFORCED RESIN COMPOSITION".
13	U.S. Application Serial No. 10/582,556 filed June 9, 2006 and entitled "THERMOPLASTIC RESIN COMPOSITION".
14	U.S. Application Serial No. 10/597,091 filed July 11, 2006 and entitled "RESIN AND RESIN COMPOSITION".
15	U.S. Application Serial No. 10/597,336 filed July 20, 2006 and entitled "POLYACETAL RESIN COMPOSITION".

EXAMINER /Adam Krupicka/

DATE CONSIDERED 11/21/2009

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.